### Variant/Label Table

<table>
<thead>
<tr>
<th>Variant</th>
<th>Label Text</th>
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<tbody>
<tr>
<td>001</td>
<td>Version E1</td>
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**Variant Notes:**

- **Variant 001:**
  - PCB Label
  - Size: 0.65" x 0.20"
  - These assemblies are ESD sensitive, ESD precautions shall be observed.
  - These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
  - These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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**PCB Label:**

- Logos and symbols are applicable for PCB labels only.
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